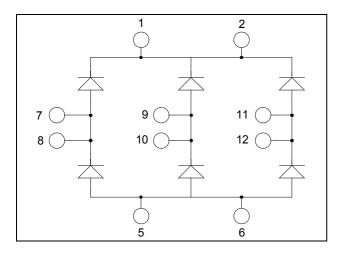


# 3 Phase rectifier bridge Power Module





# Application

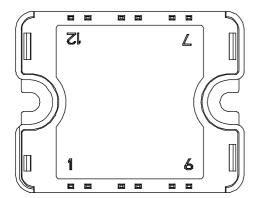
- Input rectifiers for inverter
- Battery DC power supply

#### **Features**

- High blocking voltage
- High surge current
- Low leakage current
- Very low stray inductance
  - Symmetrical design
- High level of integration



- Solderable terminals for easy PCB mounting
- Direct mounting to heatsink (isolated package)
- Low profile
- RoHS compliant



All multiple inputs and outputs must be shorted together 1/2; 5/6; 7/8; 9/10; 11/12

#### Absolute maximum ratings

Symbol	Parameter			Max ratings	Unit
$V_R$	Maximum DC reverse Voltage			1600	V
$V_{RRM}$	Maximum Peak Repetitive Reverse Voltage			1000	v
$I_{\mathrm{F}}$	DC Forward Current		$T_C = 80$ °C	90	٨
$I_{FSM}$	Non-Repetitive Forward Surge Current	t=10ms	$T_J = 45^{\circ}C$	850	А

CAUTION: These Devices are sensitive to Electrostatic Discharge. Proper Handling Procedures Should Be Followed. See application note APT0502 on www.microsemi.com

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### All ratings @ $T_j = 25$ °C unless otherwise specified

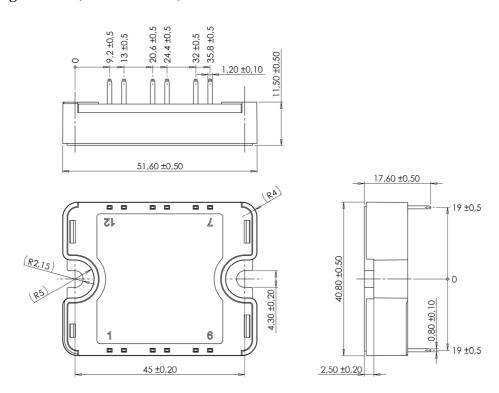
### **Electrical Characteristics**

Symbol	Characteristic	Test Conditions		Min	Typ	Max	Unit
$I_R$	Reverse Current	$V_R = 1600V$	$T_j = 25$ °C		50		μΑ
			$T_j = 125$ °C		4		mA
$V_{\scriptscriptstyle F}$	Forward Voltage	$I_F = 90A$	$T_j = 25$ °C		1.3		V
			$T_j = 125$ °C		1.1		V
$V_{T}$	On – state Voltage				0.8		V
$r_{\mathrm{T}}$	On – state Slope resistance				4.8		mΩ

### Thermal and package characteristics

Symbol	Characteristic			Min	Typ	Max	Unit
$R_{thJC}$	Junction to Case Thermal Resistance					0.85	°C/W
V <sub>ISOL</sub>	RMS Isolation Voltage, any terminal to case t =1 min, 50/60Hz			4000			V
$T_{J}$	Operating junction temperature range			-40		150	
T <sub>STG</sub>	Storage Temperature Range			-40		125	°C
$T_{\rm C}$	Operating Case Temperature			-40		100	
Torque	Mounting torque	To heatsink	M4	2		3	N.m
Wt	Package Weight					80	g

### SP1 Package outline (dimensions in mm)

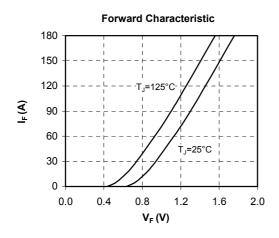


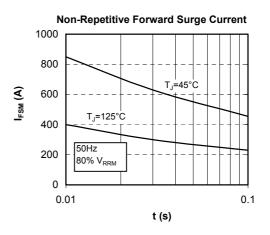
See application note 1904 - Mounting Instructions for SP1 Power Modules on www.microsemi.com

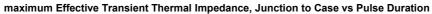
2 - 4

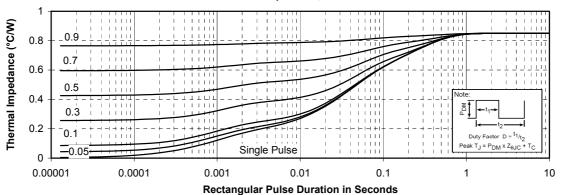


### **Typical Performance Curve**









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